

# Coiltronics FP1008 Family

## High frequency, high current power inductors



### Applications

- Multi-phase and Vcore regulators
- Voltage Regulator Modules (VRMs)
- Desktop and server VRMs and EVRDs
- Laptop and notebook regulators
- Data networking and storage systems
- Graphics cards and battery power systems
- Point-of-Load modules
- DCR Sensing circuits

### Environmental data

- Storage temperature range (Component):  
-40°C to +125°C
- Operating temperature range: -40°C to +125°C  
(ambient + self-temperature rise)
- Solder reflow temperature:  
J-STD-020D compliant

### Product description

- High current carrying capacity
- Low core loss
- Controlled DCR for sensing circuits
- Inductance range from 120nH to 180nH
- Current range from 63 to 100 Amps
- 10.8 x 8.0mm footprint surface mount package  
in a 8.0mm height
- Ferrite core material
- Halogen free, lead free, RoHS compliant



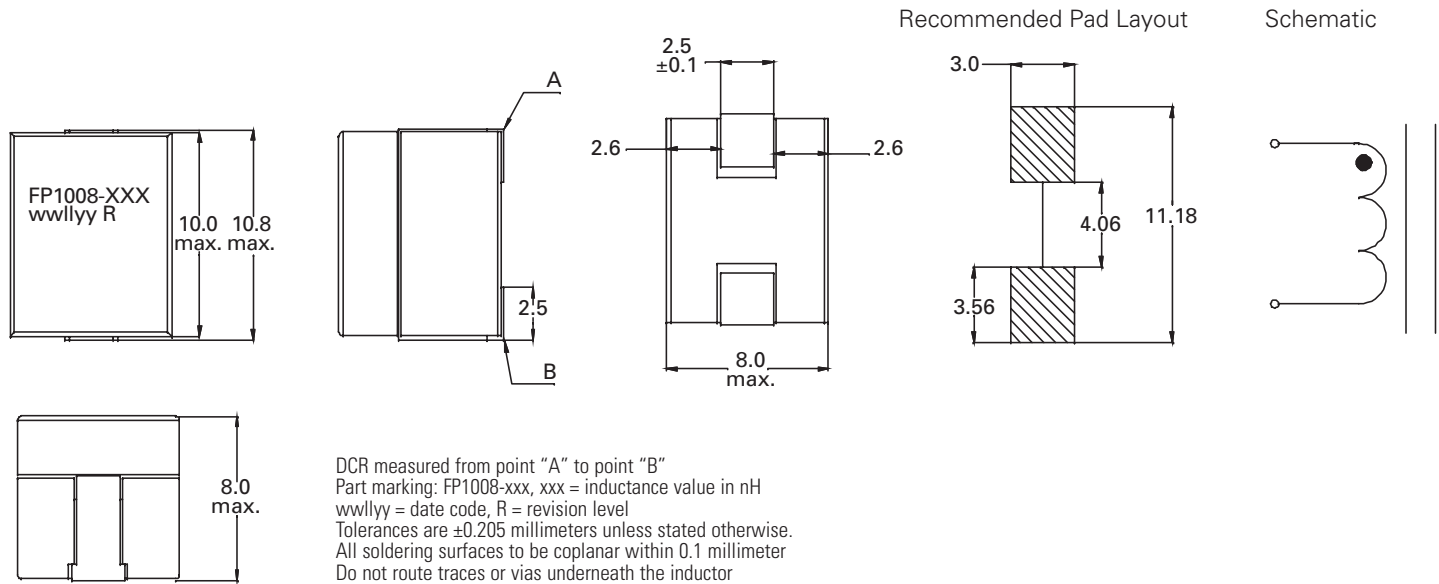
Product specifications

Part Number <sup>9</sup>	OCL <sup>1</sup> (nH)±10%	FLL <sup>2</sup> (nH) minimum	I <sub>rms</sub> <sup>3</sup> (amps)	I <sub>sat</sub> 1 <sup>4</sup> (amps)	I <sub>sat</sub> 2 <sup>5</sup> (amps)	I <sub>sat</sub> 3 <sup>6</sup> (amps)	I <sub>sat</sub> 4 <sup>7</sup> (amps)	DCR (mΩ) @ 20°C ±5%	K-factor <sup>8</sup>
FP1008-120-R	120	82	63	100	95.0	91.0	82	0.17	366
FP1008-150-R	150	104	63	82	78.0	75.0	68	0.17	366
FP1008-180-R	180	130	63	64	60.8	58.6	53	0.17	366

- Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.1V<sub>rms</sub>, 0.0Adc @ 25°C
- Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1V<sub>rms</sub>, I<sub>sat</sub>1
- I<sub>rms</sub>: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
- I<sub>sat</sub>1: Peak current for approximately 20% rolloff @ 25°C
- I<sub>sat</sub>2: Peak current for approximately 20% rolloff @ 85°C
- I<sub>sat</sub>3: Peak current for approximately 20% rolloff @ 100°C

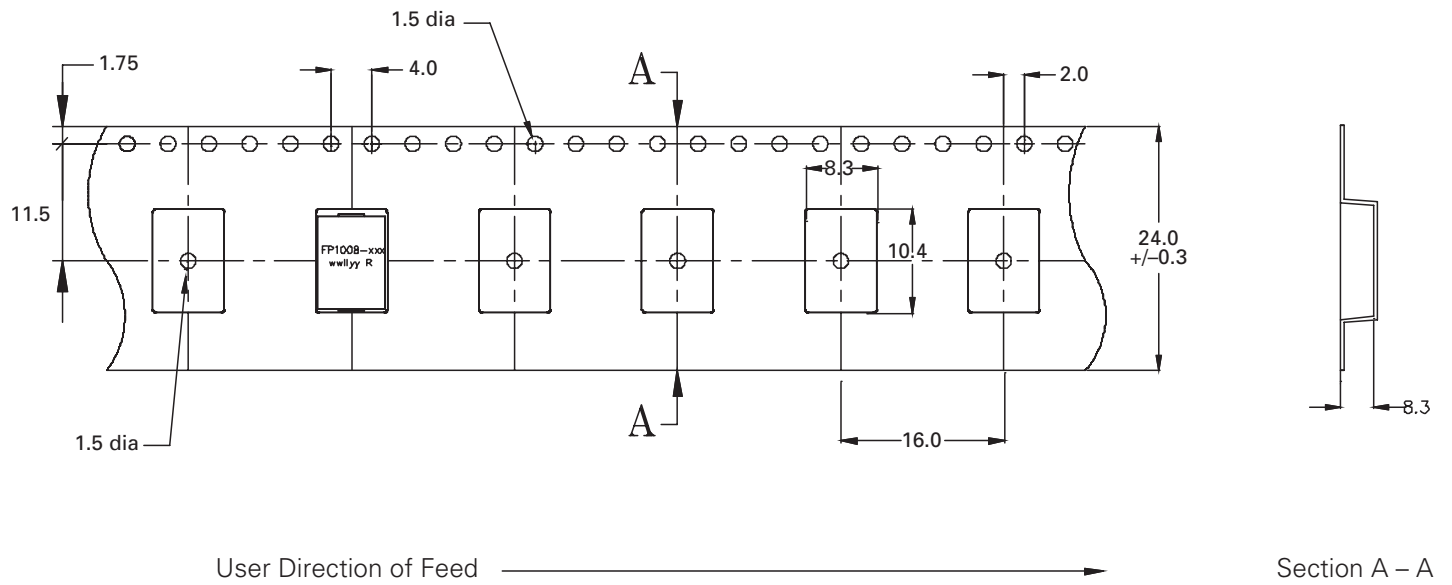
- I<sub>sat</sub>4: Peak current for approximately 20% rolloff @ 125°C
- K-factor: Used to determine B<sub>pp</sub> for core loss (see graph).  
B<sub>pp</sub> = K \* L \* ΔI \* 10<sup>-3</sup>. B<sub>pp</sub> (Gauss), K: (K-factor from table),  
L: (Inductance in nH), ΔI (Peak-to-peak ripple current in Amps).
- Part Number Definition: FP1008-xxx-R  
- FP1008= Product code and size  
- xxx= Inductance value in nH  
- "-R" suffix = RoHS compliant

Dimensions (mm)

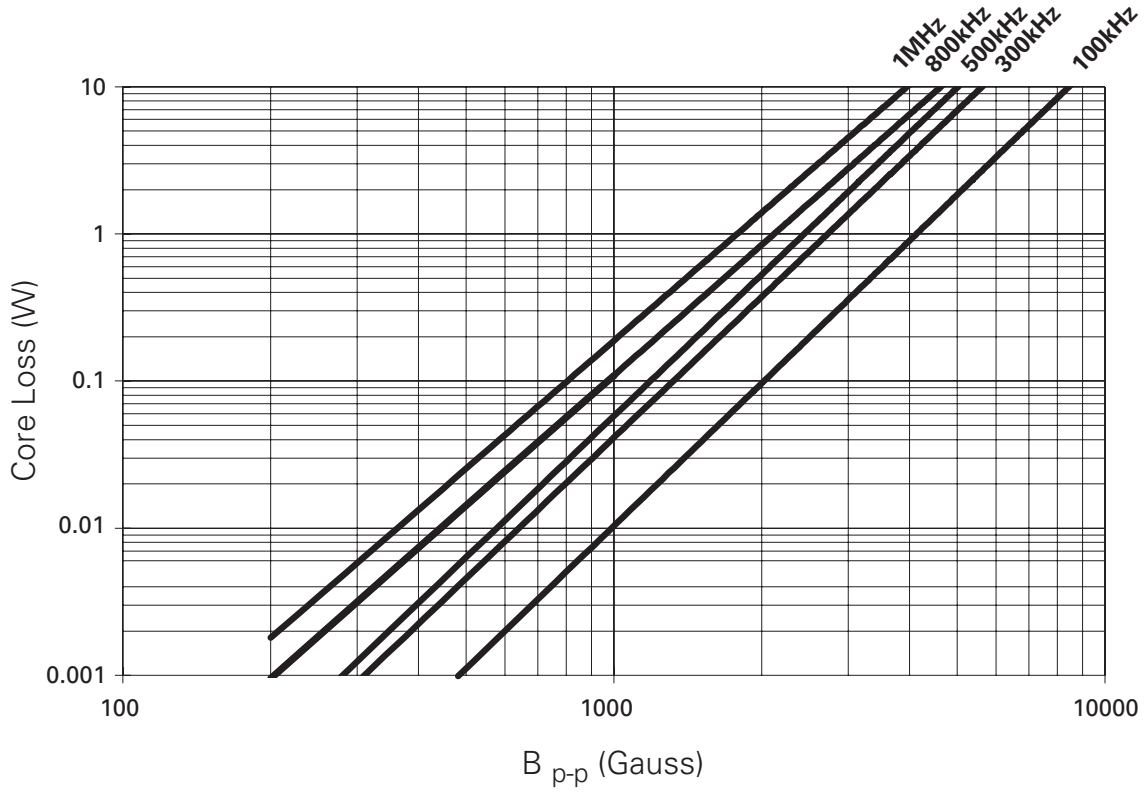


**Packaging information (mm)**

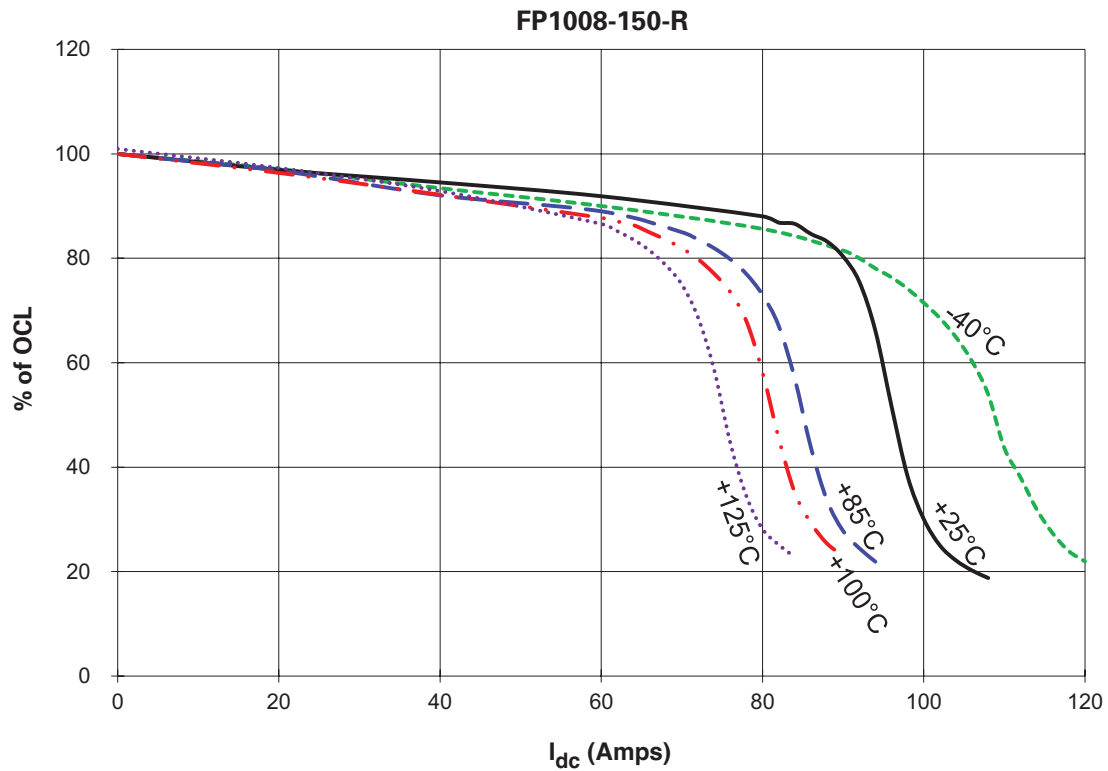
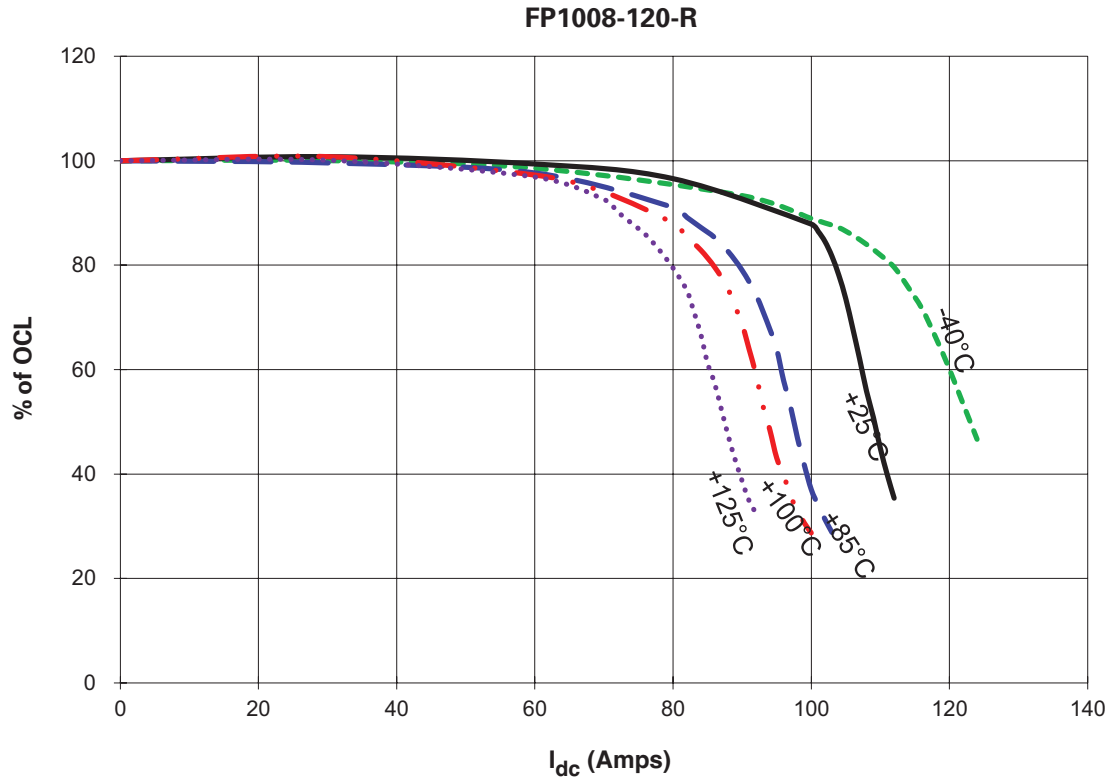
Supplied in tape-and-reel packaging, 350 parts on a 13" diameter reel.



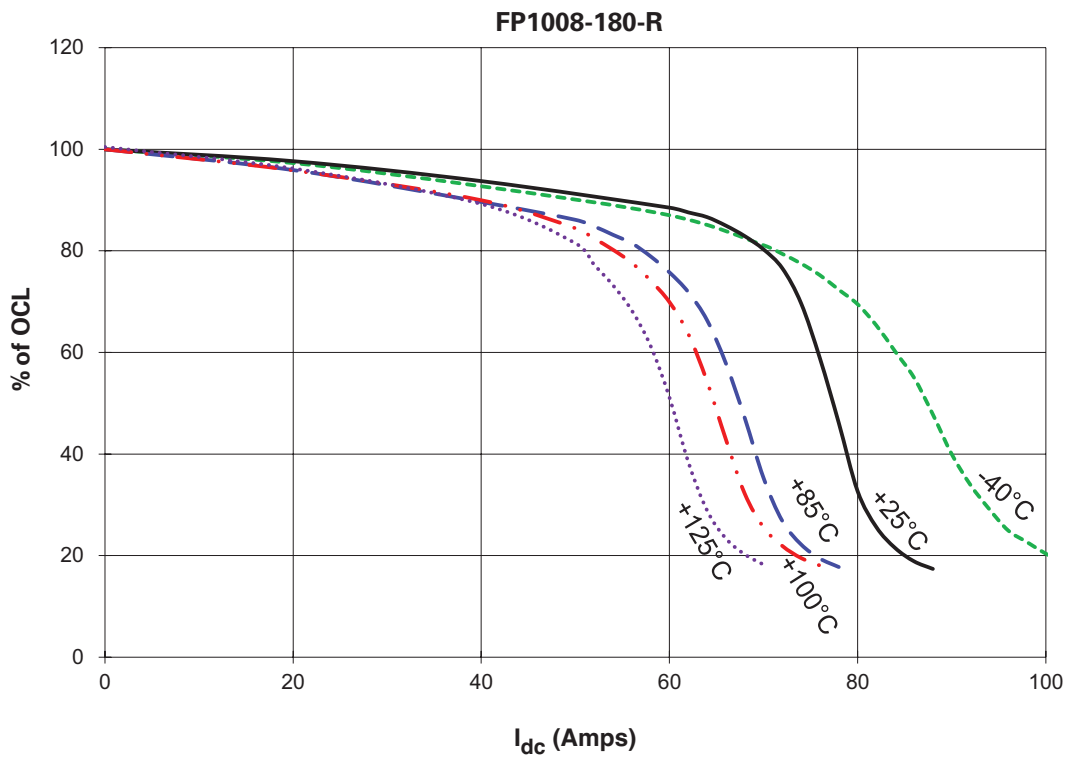
**Core loss vs. B<sub>p-p</sub>**



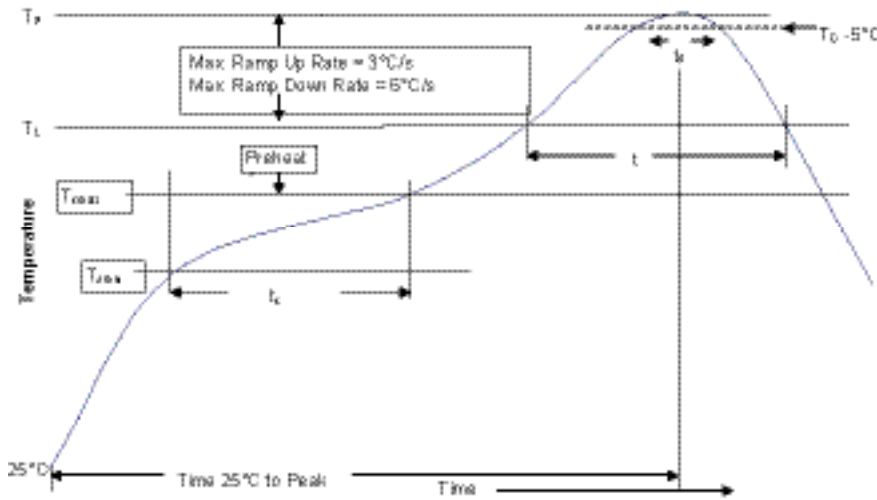
Inductance characteristics



Inductance characteristics



**Solder reflow profile**



**Table 1 - Standard SnPb Solder (T<sub>C</sub>)**

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

**Table 2 - Lead (Pb) Free Solder (T<sub>C</sub>)**

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

**Reference JDEC J-STD-020D**

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak		
• Temperature min. (T <sub>smin</sub> )	100°C	150°C
• Temperature max. (T <sub>smax</sub> )	150°C	200°C
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 Seconds	60-120 Seconds
Average ramp up rate T <sub>smax</sub> to T <sub>p</sub>	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (T <sub>L</sub> )	183°C	217°C
Time at liquidous (t <sub>L</sub> )	60-150 Seconds	60-150 Seconds
Peak package body temperature (T <sub>p</sub> )*	Table 1	Table 2
Time (t <sub>p</sub> )** within 5 °C of the specified classification temperature (T <sub>C</sub> )	20 Seconds**	30 Seconds**
Average ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

\* Tolerance for peak profile temperature (T<sub>p</sub>) is defined as a supplier minimum and a user maximum.

\*\* Tolerance for time at peak profile temperature (t<sub>p</sub>) is defined as a supplier minimum and a user maximum.

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Printed in USA  
Publication No. 10155 — BU-SB14841  
March 2015

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